

Thin film Pb/Nb photocathodes

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MS 80 Demonstrated operation of improved deposition system, Pb layers of 1 µm in thickness

D12.8 Optimised procedure for microdroplets flattening with an UV laser

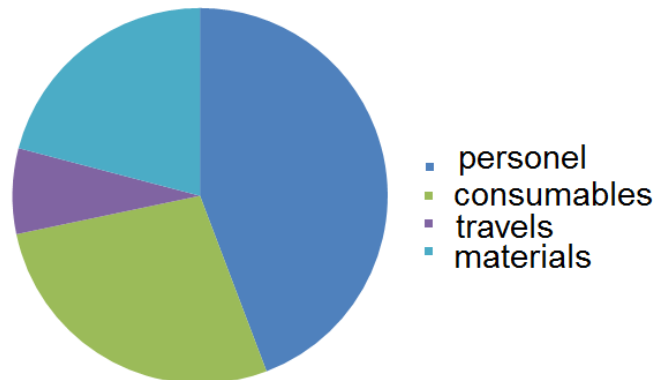


D12.8 Optimised procedure for preparation of flat, clean and adherent Pb/Nb films

Reason

We found that plasma pulsed irradiation is more effective than the laser one. For plasma we learned how thick layer must be deposited to undergo a right change caused by energy deposition.

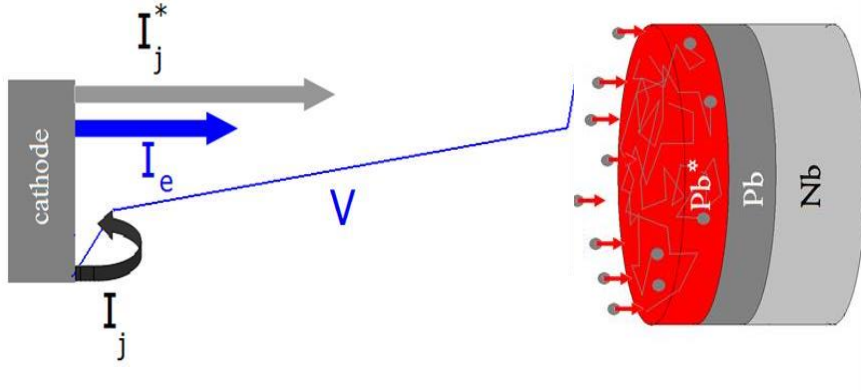
Beneficiary	Person* month	Personel cost per month	Personel direct	Personel indirect	Consumables	Travel direct	Materials and travels	Total direct	Total indirect	Total direc +indir	EC contribution
NCBJ	36	1927	69,389	41,634	69,000	18,500	52,500	156,889	94,134	251,023	98,134





Cathodic arc

Explosive electron and Pb ions emission, ions accelerated in the pressure gradient and coupled to the electron flux

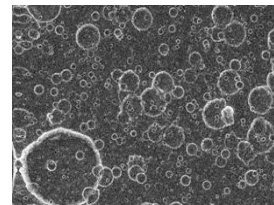
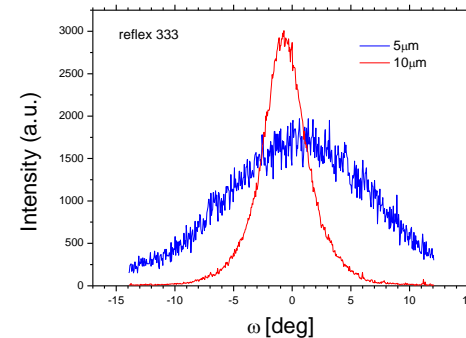


Consequences for the film:

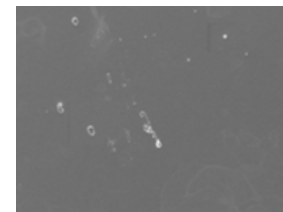
- regular
- dense
- adherent
- texture (111)
- micro-droplets

Growth

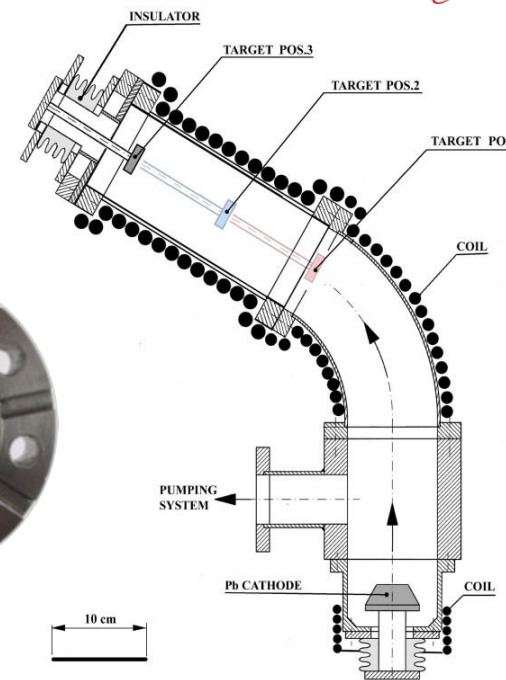
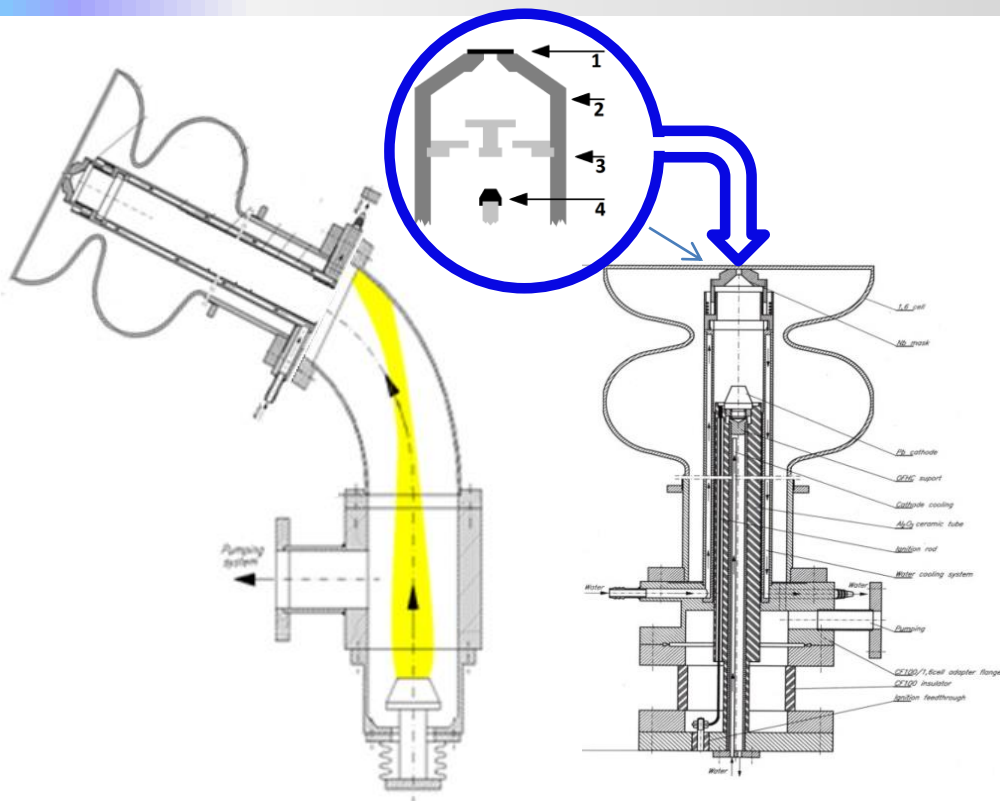
- Shallow implantation
- diffusion with kinetic energy higher than displacement energy
- permanent ion exceed
- gradual cooling and condensation



unfiltered



filtered



Knee-like magnetic filter, deposition directly onto cavity back wall

Short distance – short time

Detachable plug, treatment of which is separated from the e-gun cavity. Performance has been tested vs the plasm channel length

Low througput long time, debrees

still debrees

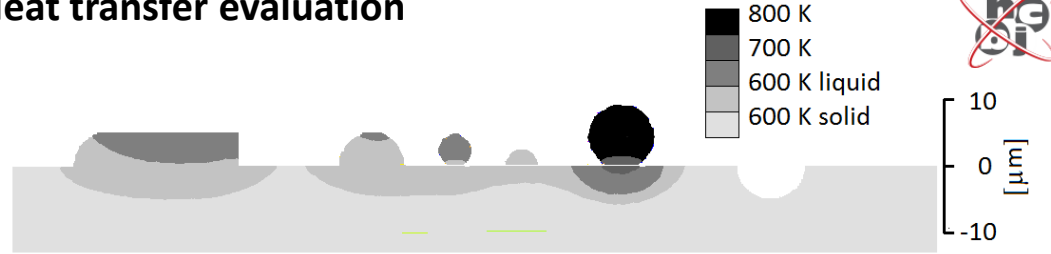


No trade off between droplets removal efficiency and surface cleanliness has been found

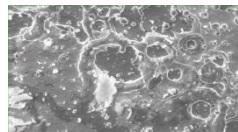
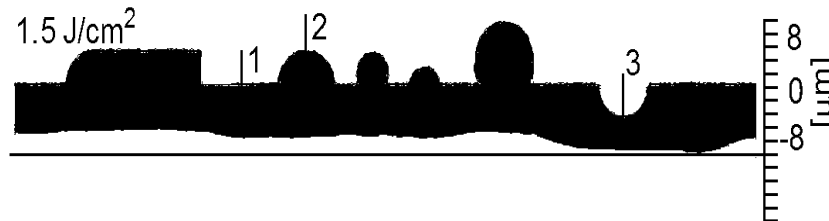
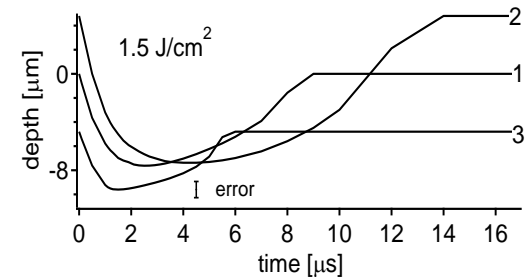


Unfiltered deposition followed with a separated flattening

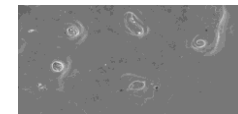
Heat transfer evaluation



- Film molten down to 9 μm during 6 - 14 μs
- Interface remains solid
- Droplets stay liquid the longest time

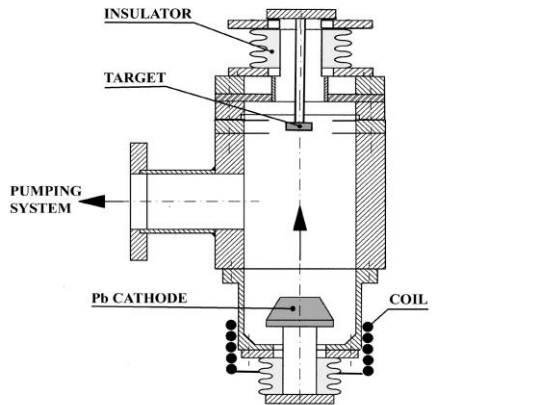


8 μm heavily damaged with 1.8 J/cm^2

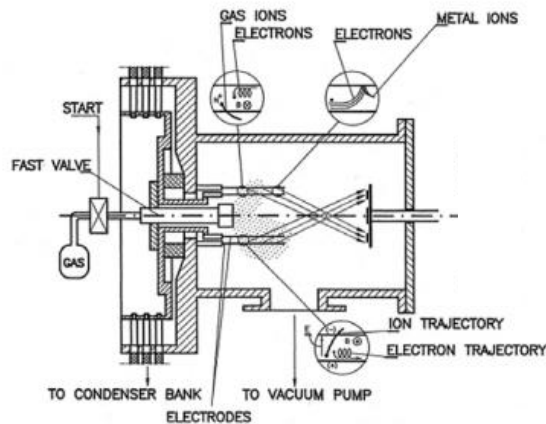


12 μm accidentally perforated with $3 \times 1.5 \text{ J}/\text{cm}^2$

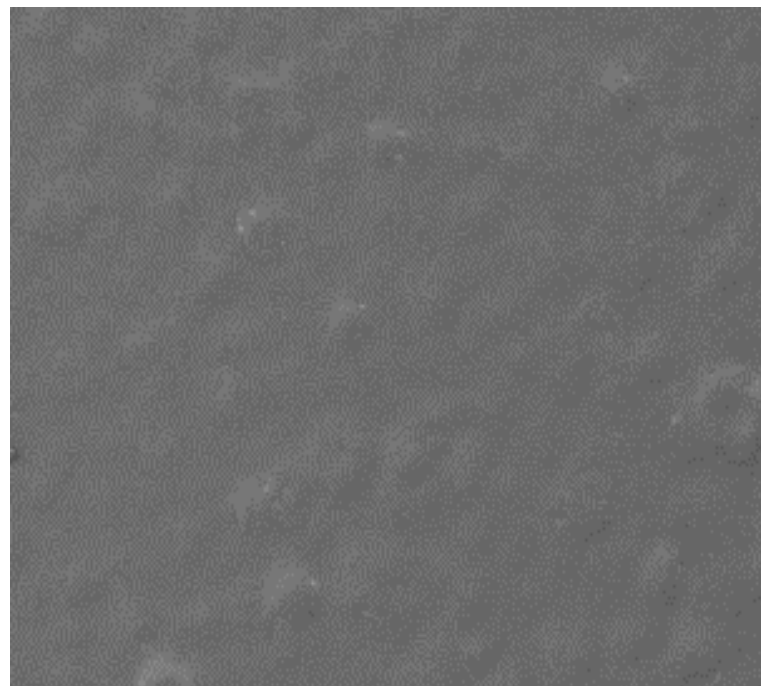
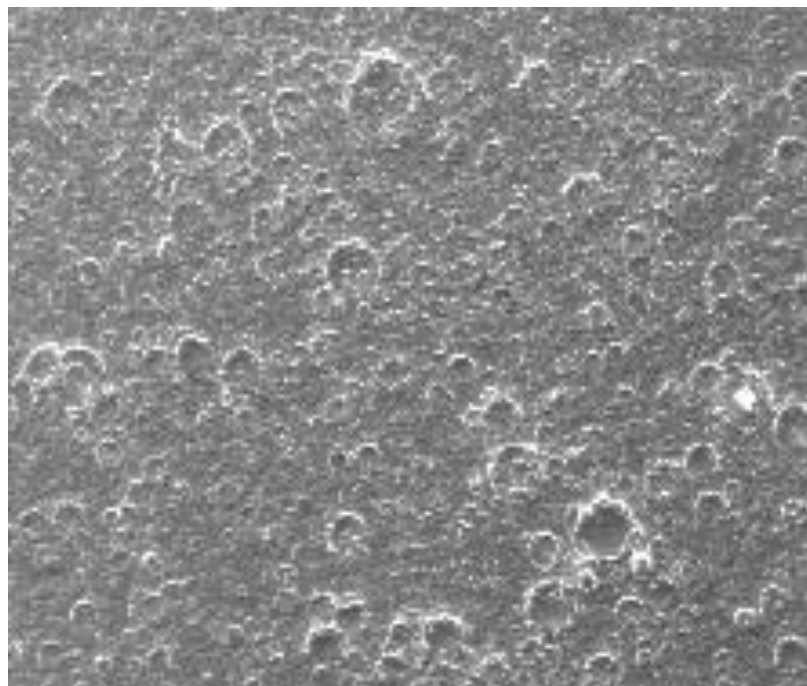
20 μm ,
 $6 \times 1.5 \text{ J}/\text{cm}^2$



Direct deposition several μm



Melting and flattening with Rod Plasma Injector
1 J/cm^2 , 1 μs Ar^+ pulses

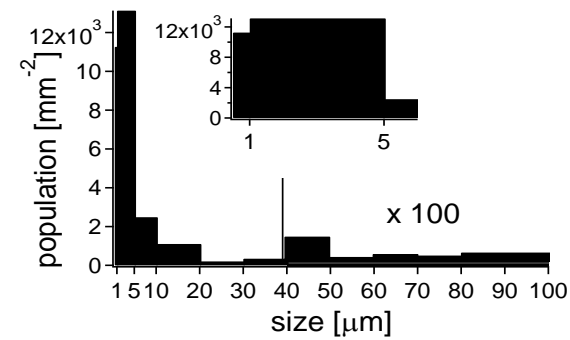
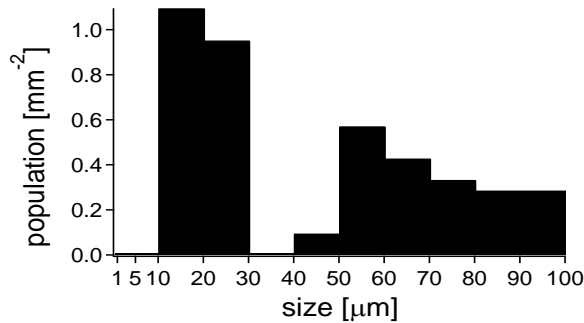


—
200 μm

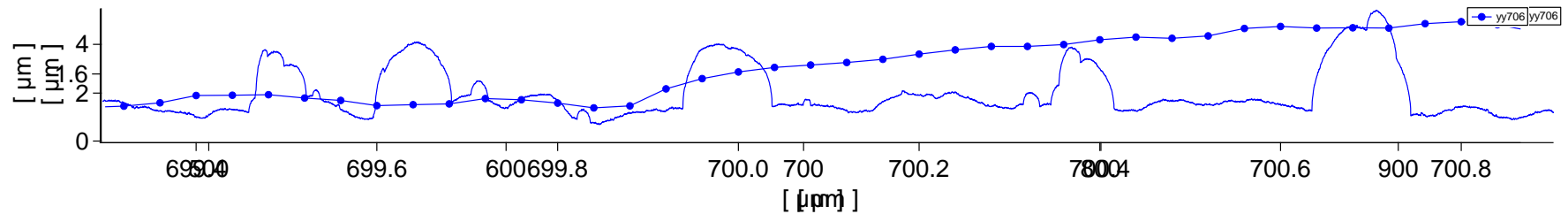
Applied treatment resulted in a continuous and uniform layer.

population	$3 \cdot 10^4 \text{ mm}^{-1}$	5 mm^{-1}
droplets coverage	0.85	0.01
altitude difference	50 μm	1 μm (5 μm)
lateral correlation length	1 μm	100 μm

20 μm,
 $6 \times 1.5 \text{ J/cm}^2$



- $0.4 \times 4 \text{ mm}^2$ model areas were populated with droplets ensembles of radii distributions found with SEM inspection for as deposited and flattened samples, respectively
- Centres locations of hemispherical extrusions have been randomly chosen on the model areas in the grids of 40 nm resolving mesh
- Surface cross sections profiles along randomly chosen 4 mm long straight lines have been calculated



- Distributions of fragments normals inclination angles to the overall surface normal has been calculated
- Electric field was calculated in the surface vicinity by applying a voltage between that surface and the plane in the infinity, which corresponds to 40 MV/m at the ideally flat surface

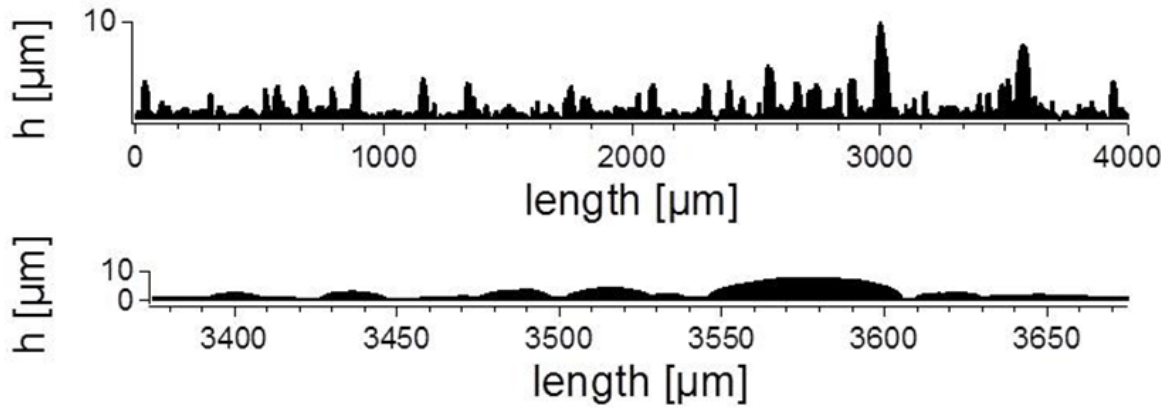


Fig. 8. Modelled surface profile for the as deposited sample. a. – entire model surface, the vertical dimension is 40 times magnified; b. - a specific region drawn in natural aspect ratio

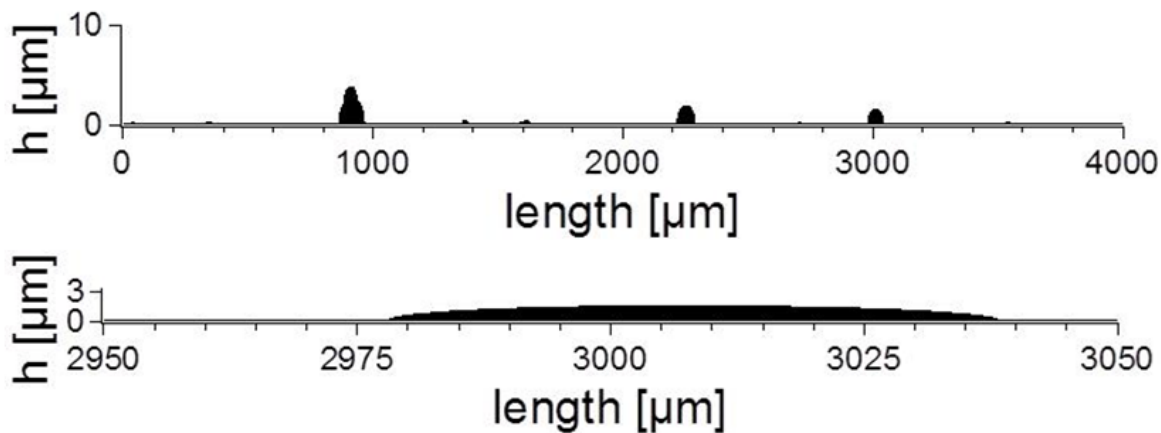
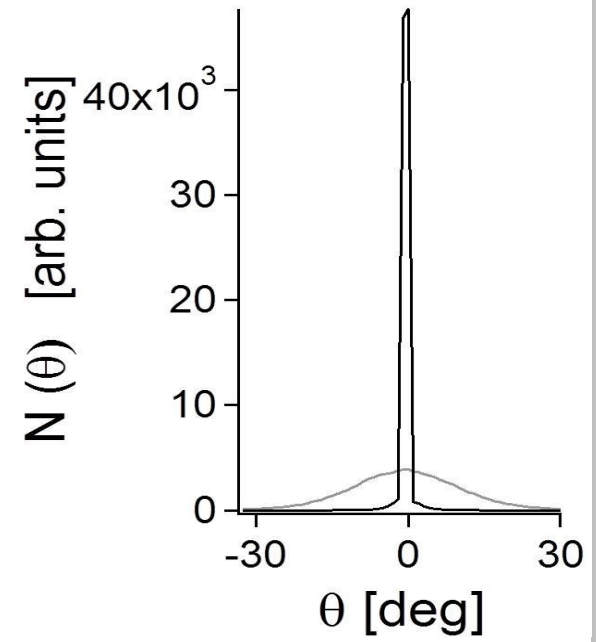
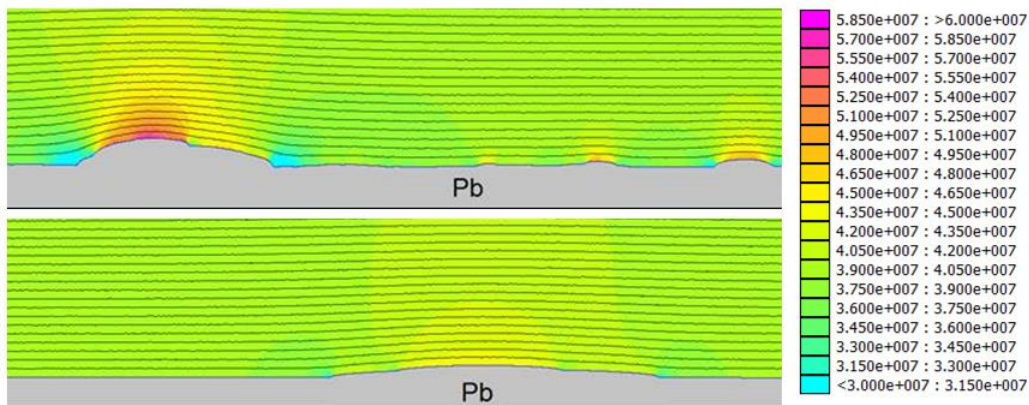


Fig. 9. Modelled surface profile for the flattened sample. a. – entire model surface, the vertical dimension is 40 times magnified; b. - a specific region drawn in natural aspect ratio



A fraction of 0.96 the surface inclined within angular ranges:

- fs deposited: $\pm 25^\circ$
- flattened: $\pm 5^\circ$



Electric field inhomogeneity :

as deposited: 20 - 60 MV/m

flattened: 37 - 46 MV/m

Fig. 11. Maps of electric field in the vicinity of modelled surface. a. – as deposited sample; b. – flattened sample

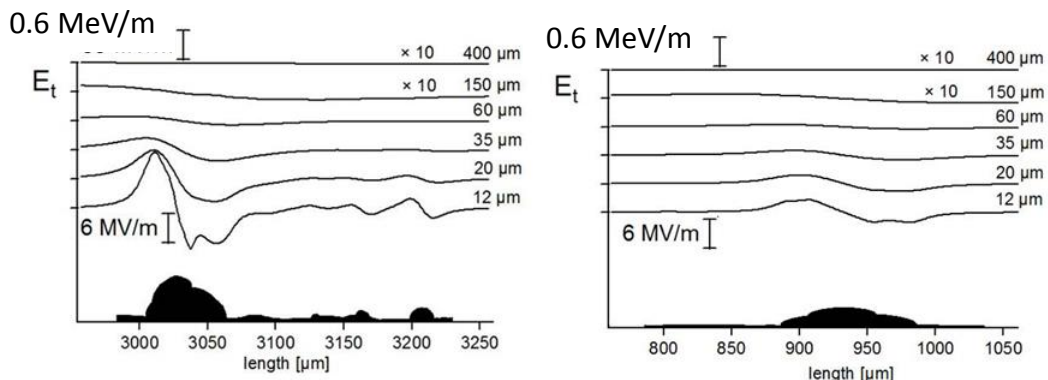


Fig. 12. Transverse contribution of the electric field calculated for the model surface for the regions containing the highest protrusions. a. – as deposited sample; b. – flattened sample

- ➡ after flattening a transverse field is 5 times weaker
- ➡ no transverse field beyond 400 μm



E_{cathode}	40 MV/m
QE at 266 nm	$1.8 \cdot 10^{-4}$
Bunch rep. rate	100-250 kHz
Bunch charge	250-100 pC
P of irradiating laser at 266nm	1 W
Normalized emittance for 250pC	$<0.5 \mu\text{m rad}$

266 nm, 10 μJ , 5 ps, 100 kHz

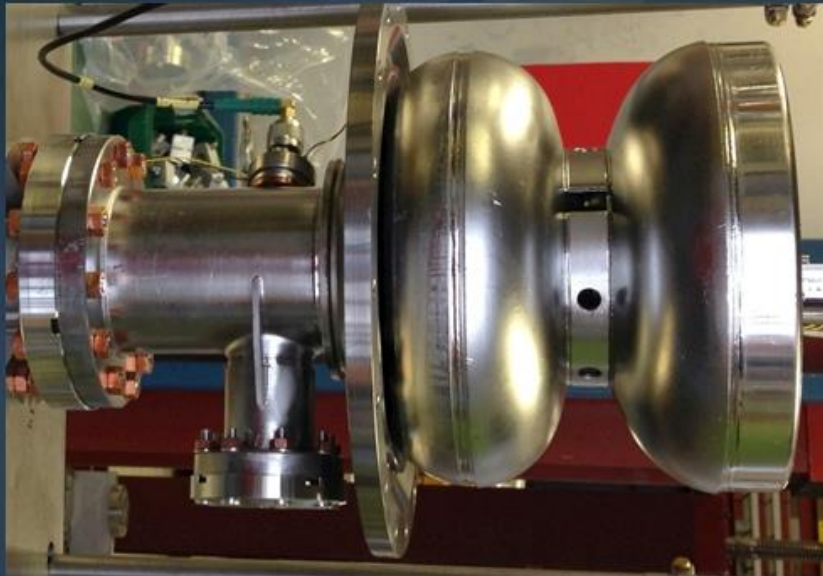


380 pC, 38 μA

Long term stability is being tested at HZDR

- ➡ Dark current modelling base on breakdown current measurements with pulsed E field
- ➡ Beam dynamics calculation – emittance evaluation

The 1.5-cell gun cavity prototype was built at TJNAF. The present plug version has very effective cooling of the cathode.



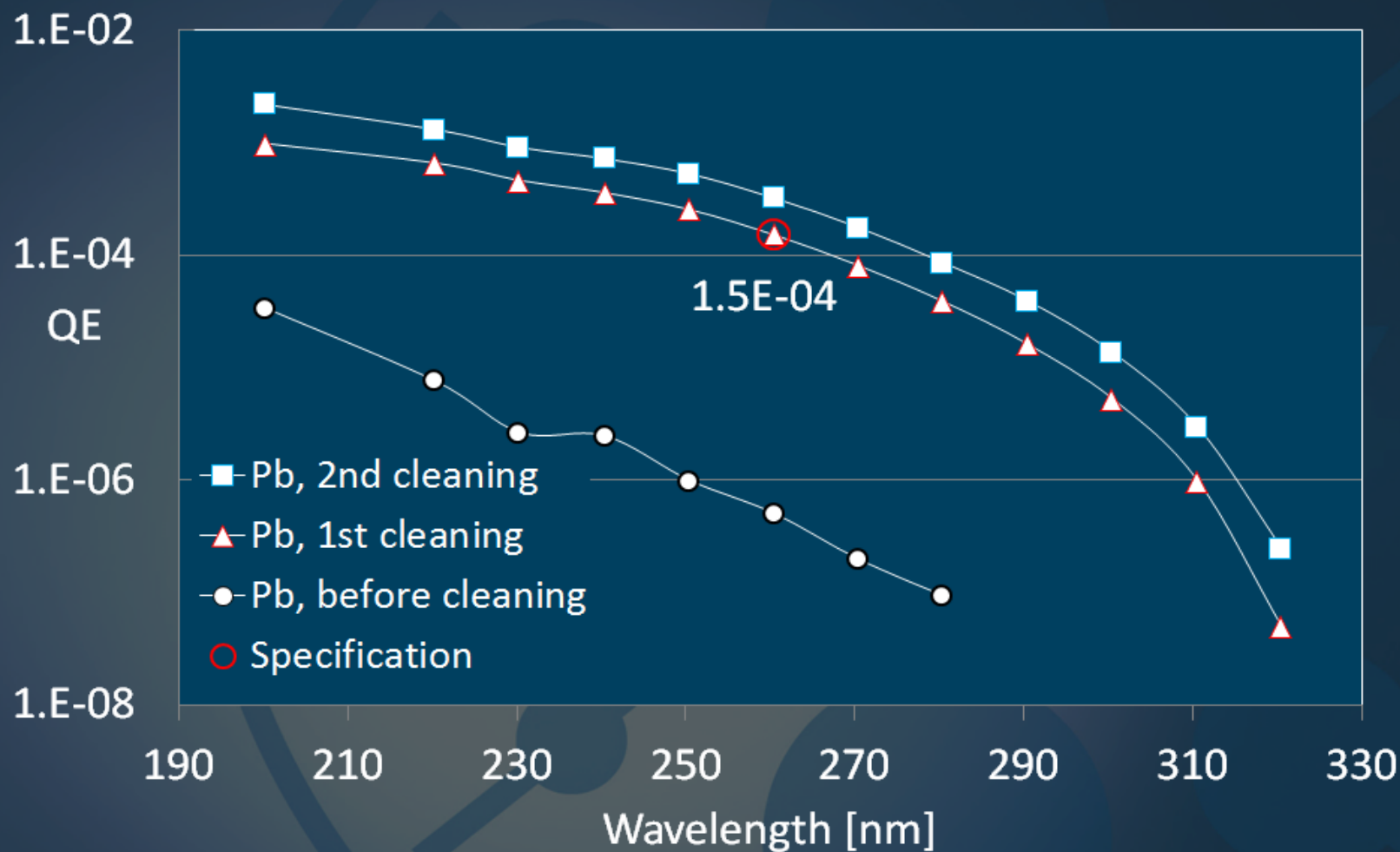
1.5-cell , 1.3 GHz gun cavity



New plug with
LHe channels



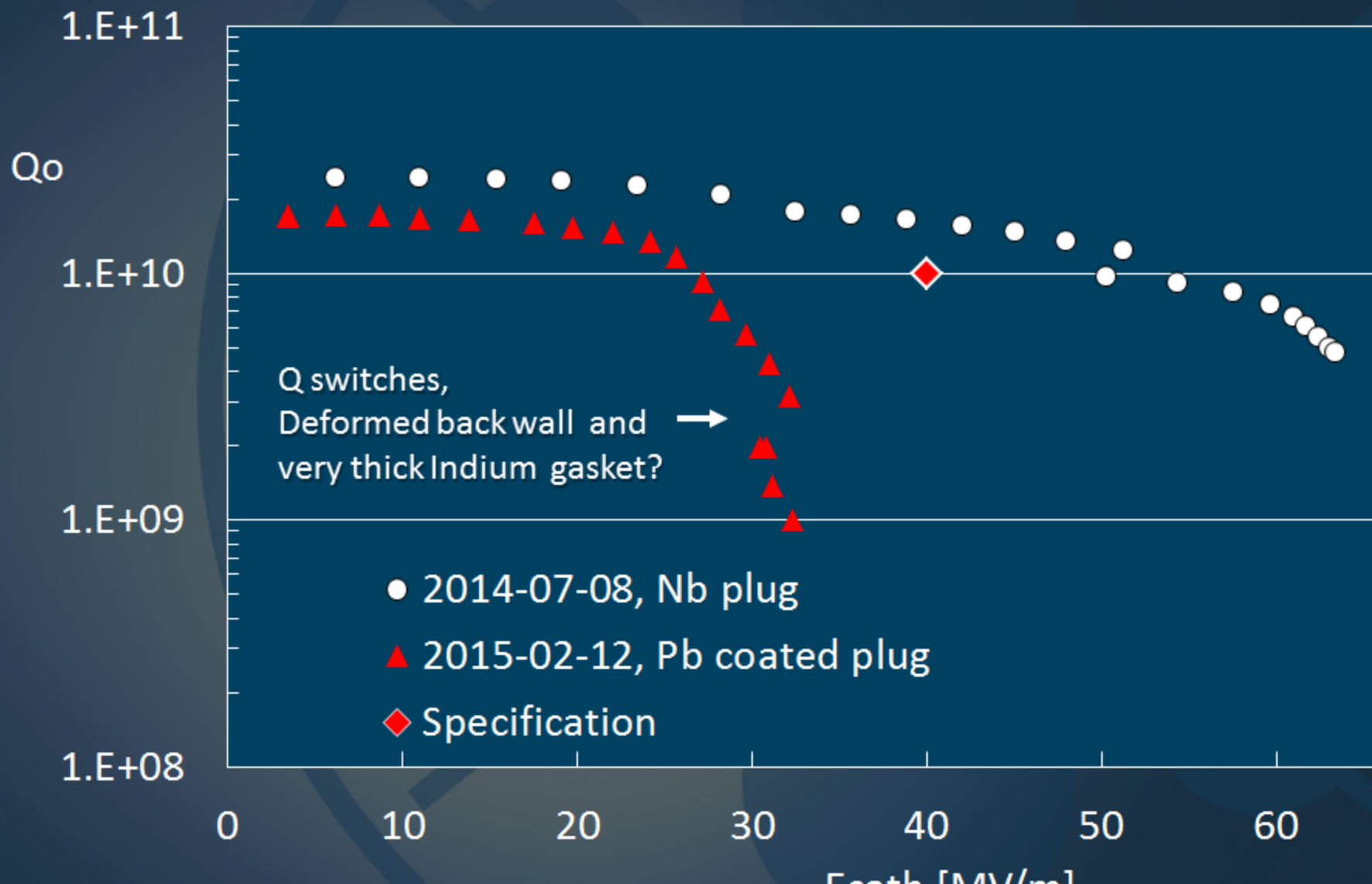
Nb/Pb
cathode

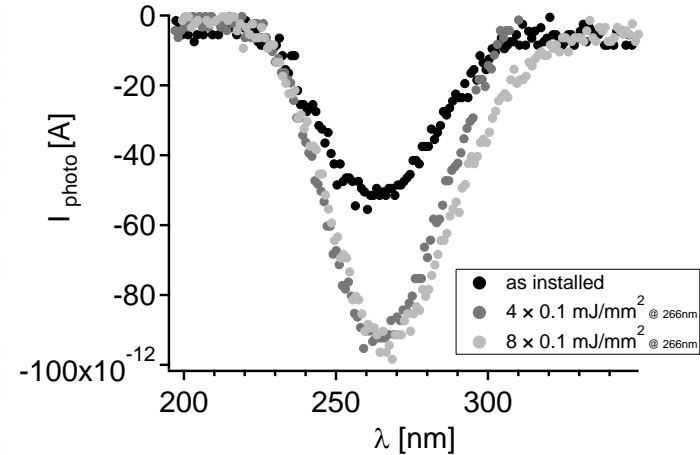
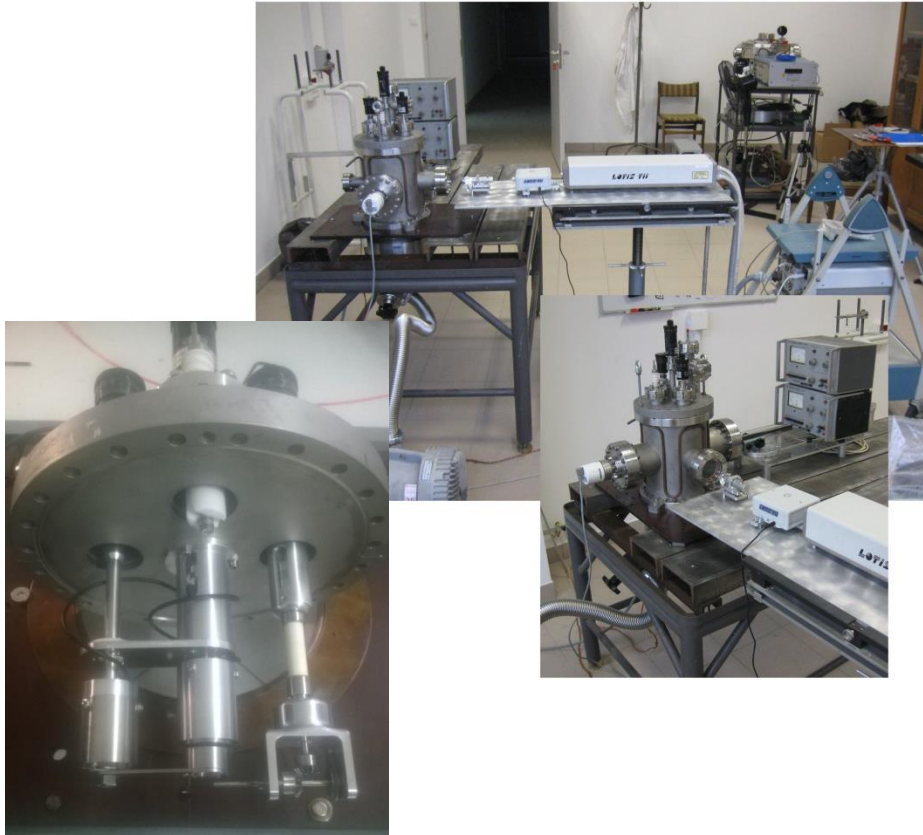
Recent QE test at BNL of the Pb coating on new plug

Courtesy J. Smedley, J. Sinsheimer,
M. Gaowei and V. Gofron

Laser cleaning: 1st 1000 shots with 0.06 mJ/mm²,
2nd 10000 shots with 0.06 mJ/mm², all at 248nm

The test results of 1.5-cell gun cavity with Nb and Pb-coated cathode





Pb/Nb Sample ex-situ prepared with 200 pulses of 0.5 mJ/mm^2 at 532 nm then treated with $8 \times 0.1 \text{ mJ/mm}^2$ at 266 with .
 $QE = 6 \cdot 10^{-4} \pm 5 \cdot 10^{-4}$ (preliminary results)

Built since 2014:

150 W Xe lamp + monochromator + fiber optical path + picoamperometer

255 nm 1 W diodes

Nd YAG +IV harmonics generator 30 μJ , 10 ns, 20 Hz + collimation

Pulser 12.5 kV + 50 μm precise manipulators: 1. sample holder, 2. Farady cup



MS 80 Demonstrated operation of improved deposition system, Pb layers of 1 μm in thickness

Direct arc deposition

D12.8 Optimised procedure for microdroplets flattening with an UV laser

Pulsed plasma flattening



Thanks for the attention

Thanks for the collaboration on photocathodes and innovative RF technologies